

Vishay

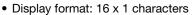
COMPLIANT

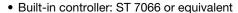
16 x 1 Character LCD



FEATURES

· Type: Character





• Duty cycle: 1/16

• 5 x 8 dots includes cursor

• + 5 V power supply

• LED can be driven by pin 1, pin 2, pin 15, pin 16, or A and K

 Material categorization: For definitions of compliance please see www.vishav.com/doc?99912

MECHANICAL I	DATA	
ITEM	STANDARD VALUE	UNIT
Module Dimension	85.0 x 28.0 x 9.7	
Viewing Area	66.0 x 16.0	
Dot Size	0.55 x 0.75	mm
Dot Pitch	0.63 x 0.83] '''''
Mounting Hole	80.0 x 23.0	
Character Size	3.07 x 6.56	

ABSOLUTE	MAXIMU	JM RA	TINGS		
ITEM	SYMBOL	STAN	IDARD V	ALUE	UNIT
I I EIVI	STWIDOL	MIN.	TYP.	MAX.	UNII
Power Supply	V_{DD} to V_{SS}	- 0.3	-	7.0	V
Input Voltage	VI	V _{SS}	-	V_{DD}	[

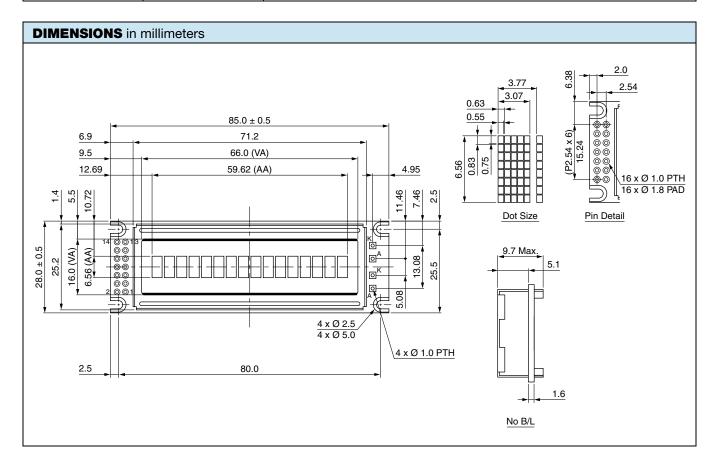
Note

• V_{SS} = 0 V, V_{DD} = 5.0 V

ELECTRICAL CHARACTE	RSITICS					
ITEM	SYMBOL	CONDITION	ST	ANDARD VAL	.UE	UNIT
II EIWI	STIVIBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Input Voltage	V_{DD}	$V_{DD} = + 5 V$	4.5	5.0	5.5	V
Supply Current	I _{DD}	$V_{DD} = + 5 V$	-	1.2	-	mA
		- 20 °C	-	-	5.5	
Recommended LC Driving		0 °C	-	-	-	
Voltage for Normal Temperature	V_{DD} to V_{0}	25 °C	4.2	4.35	4.5	V
Version Module		50 °C	-	-	-	
		70 °C	3.5	-	-	
LED Forward Voltage	V_{F}	25 °C	-	-	-	V
LED Forward Current	I _F	25 °C	-	-	-	mA
EL Power Supply Current	I _{EL}	V _{EL} = 110 V _{AC} , 400 Hz	-	-	-	mA

DISPLAY CHAR	ACTE	ER AC	DRE	ss c	ODE											
Display Position																
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
DD RAM Address	00	01	02	03	04	05	06	07	40	41	42	43	44	45	46	47

INTERFACE PI	N FUNCTION	
PIN NO.	SYMBOL	FUNCTION
1	V _{SS}	Ground
2	V _{DD}	Supply voltage for logic (+ 5 V)
3	V ₀	Operating voltage for LCD (variable)
4	RS	H/L; H: data/L: instruction code
5	R/W	H/L; H: read (MPU \rightarrow module)/L: write (MPU \rightarrow module)
6	E	$H, H \rightarrow L$ chip enable signal
7	DB0	H/L data bus line
8	DB1	H/L data bus line
9	DB2	H/L data bus line
10	DB3	H/L data bus line
11	DB4	H/L data bus line
12	DB5	H/L data bus line
13	DB6	H/L data bus line
14	DB7	H/L data bus line





1. Module Classification Information

1. Brand: Vishay Intertechnology, Inc.

2. Horizontal Format: 16 characters

3. Display Type : N→Character Type, H→Graphic Type

4. Vertical Format: 1 line

5. Model serials no.: B

6. Backlight Type: $N \rightarrow Without$ backlight $T \rightarrow LED$, White

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber

D→EL, Green R→LED, Red

 $W\rightarrow EL$, White $O\rightarrow LED$, Orange

 $F \rightarrow CCFL$, White $G \rightarrow LED$, Green

Y→LED, Yellow Green

7. LCD Mode : B→TN Positive, Gray T→FSTN Negative

N→TN Negative,

G→STN Positive, Gray

Y→STN Positive, Yellow Green

M→STN Negative, Blue

F→FSTN Positive

8. LCD Polarizer A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00

range/ View direction G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

9. Special Code ET: English and European standard font

Compliant with the ROHS Directions and regulations



2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) Supplier has the right to change the passive components
- (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Supplier has the right to change the PCB Rev.

3. General Specification

ITEM	STANDARD VALUE	UNIT
Number of Characters:	16 characters×1 Lines	
Module dimension:	85.0×28.0×9.7(MAX)mm	mm
View area:	66.0×16.0mm	mm
Active area:	59.62×6.56mm	mm
Dots size:	(L)0.55×(W)0.75mm	mm
Dots pitch:	(L)0.63×(W)0.83mm	mm
Character size:	(L)3.07×(W)6.56mm	mm
Character pitch:	(L)3.77×(W)6.56mm	mm
LCD type:	STN Positive, Gray Reflect: (In LCD production, It will occur slightly We can only guarantee the same color in t	color difference.
Duty:	1/16	
View direction:	6 o'clock	
Backlight Type	Without backlight	



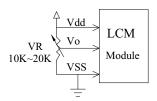
4. Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\! \mathbb{C}$
Input Voltage	V _I	V_{SS}	_	$V_{ m DD}$	V
Supply Voltage For Logic	V _{DD} -V _{SS}	-0.3	_	7	V
Supply Voltage For LCD	V_{DD} - V_0	-0.3	_	13	V

5. Electrical Characteristics

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
		Ta=-20°C	_	_	5.5	V
Supply Voltage For LCD	V_{DD} - V_0	Ta=25°C	4.2	4.35	4.5	V
*Note		Ta=70°C	3.5	_	_	V
Input High Vol	V_{IH}	_	$0.7\mathrm{V_{DD}}$	_	V_{DD}	V
Input Low Vol	V_{IL}	_	V_{SS}	_	0.6	V
Output High Vol	$ m V_{OH}$	_	3.9	_	V_{DD}	V
Output Low Vol.	V_{OL}	_	_	_	0.4	V
Supply Current	I_{DD}	V _{DD} =5.0V	_	1.2	_	mA

^{*} Note: Please design the VOP adjustment circuit on customer's main board





6. Optical Characteristics

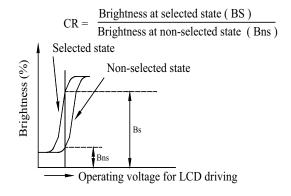
ITEM	SYMBAL	CONDITION	MIN.	TYP.	MAX.	UNIT
	(V) θ	CR≧2	20		40	deg
View Angle	(H) φ	CR≧2	-30		30	deg
Contrast Ratio	CR	_		3		_
	T rise	_		100	150	ms
Response Time	T fall	_		100	150	ms

6.1 Definitions

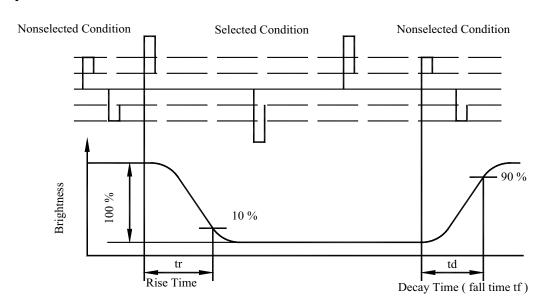
■View Angles

Z (Visual angle direction) Best visual angle direction)

Contrast Ratio



Response Time



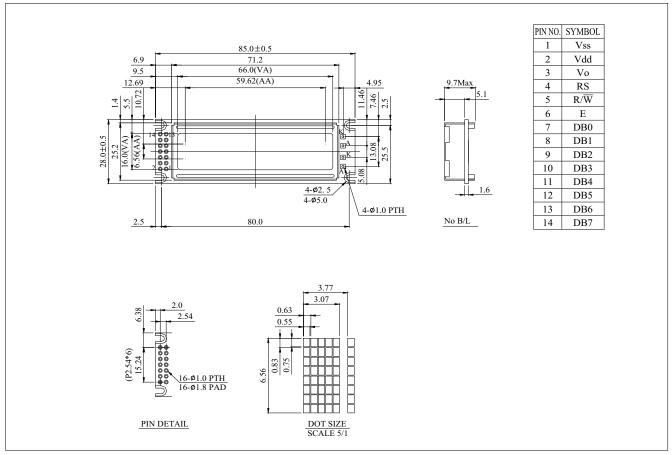


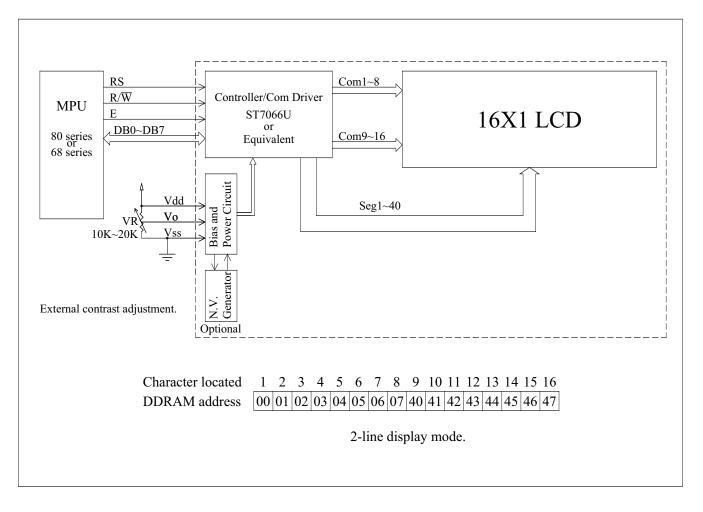
7. Interface Pin Function

Pin No.	Symbol	Level	Description
1	V_{SS}	0V	Ground
2	V_{DD}	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H:DATA, L: Instruction code
5	R/W	H/L	H:Read(MPU→Module)L:Write(MPU→Module)
6	Е	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line

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8. Contour Drawing & Block Diagram







9. Function Description

The LCD display Module is built in a LSI controller, the controller has two 8-bit registers, an instruction register (IR) and a data register (DR).

The IR stores instruction codes, such as display clear and cursor shift, and address information for display data RAM (DDRAM) and character generator (CGRAM). The IR can only be written from the MPU. The DR temporarily stores data to be written or read from DDRAM or CGRAM. When address information is written into the IR, then data is stored into the DR from DDRAM or CGRAM. By the register selector (RS) signal, these two registers can be selected.

RS	R/W	Operation
0	0	IR write as an internal operation (display clear, etc.)
0	1	Read busy flag (DB7) and address counter (DB0 to DB7)
1	0	Write data to DDRAM or CGRAM (DR to DDRAM or CGRAM)
1	1	Read data from DDRAM or CGRAM (DDRAM or CGRAM to DR)

Busy Flag (BF)

When the busy flag is 1, the controller LSI is in the internal operation mode, and the next instruction will not be accepted. When RS=0 and R/W=1, the busy flag is output to DB7. The next instruction must be written after ensuring that the busy flag is 0.

Address Counter (AC)

The address counter (AC) assigns addresses to both DDRAM and CGRAM

Display Data RAM (DDRAM)

This DDRAM is used to store the display data represented in 8-bit character codes. Its extended capacity is 80x8 bits or 80 characters. Below figure is the relationship between DDRAM addresses and positions on the liquid crystal display.





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AC (hexadecimal)

AC6 AC5 AC4 AC3 AC2 AC1 AC0 1 0 0 1 1 1 1

DDRAM Address

Display position DDRAM address

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
00	01	02	03	04	05	06	07	40	41	42	43	44	45	46	47

1-Line by 16-Character Display

Character Generator ROM (CGROM)

The CGROM generate 5×8 dot or 5×10 dot character patterns from 8-bit character codes. See Table 2.

Character Generator RAM (CGRAM)

In CGRAM, the user can rewrite character by program. For 5×8 dots, eight character patterns can be written, and for 5×10 dots, four character patterns can be written.

Write into DDRAM the character code at the addresses shown as the left column of table 1. To show the character patterns stored in CGRAM.

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Relationship between CGRAM Addresses, Character Codes (DDRAM) and Character patterns

Table 1.

For 5 * 8 dot character patterns

Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0	5 4 3 2 1 0	7 6 5 4 3 2 1 0	
High Low	High Low	High Low	
0 0 0 0 * 0 0 0	0 0 0 0 0 0 1 0 1 0 0 1 1 0 0 1 1 0 0 1 1 1 1 1 0 1 1 1 1 0 0 0 0 0 0 0 0 1	* * * * 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	Character pattern(1) Cursor pattern
0 0 0 0 * 0 0 1	0 1 0 0 1 1 0 0 1 1 0 0 1 0 1 1 1 0 1 1 1 0 0 0	* * * * * * * * * * * * * * * * * * *	Character pattern(2) Cursor pattern
	0 0 1		
0 0 0 0 * 1 1 1	1 1 1 1 0 0 1 0 1 1 1 0 1 1 1	* * *	

For 5 * 10 dot character patterns

Character Codes (DDRAM data)	CGRAM Address	Character Patterns (CGRAM data)	
7 6 5 4 3 2 1 0 High Low	5 4 3 2 1 0 High Low	7 6 5 4 3 2 1 0 High Low	
0 0 0 0 * 0 0 0	0 0 0 0 0 0 0 0 0 0 0 1 0 0 0 1 1 0 0 0 1 0 0 0 1 0 0 0 1 0 1 0 1 0 0 0 1 1 1 1 1 1 1 1 1 0 0 0 0 1 1 0 1 0 1 0 1 0 1 0 1 0 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 1 0 1 0 1 1 1 0 1 0 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 0 1 1 1 1 0 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 0 1 1 0 0 0 1 1 1 1 1 0 1 1 0 0 0 1	* * * * 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	Character pattern Cursor pattern
		* * * * * * * *	
		* * * * * * * *	

■ : " High "



10. Character Generator ROM Pattern

Table.2

**														1		
Upper 4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH		LHHH	HLLL	HLLH	HLHL	нгнн	HHLL	HHLH	HHHL	нннн
LLLL	CG RAM (1)	[**				-551	-	,,,,			****
LLLH	CG RAM (2)	*****	1		***			-:::[1,,.		11.	H H	.,.		****	! ;:
LLHL	CG RAM (3)		11								:::::	-:-	1,1,1		=====	*****
LLHH	CG RAM (4)				**** * _{***} *	**** ****		-:::-	-:::}	,". ::	,- !!	**	!			1,[,1
LHLL	CG RAM (5)		**!**							:::::		•*	-1:-1		*****	
LHLH	CG RAM (6)		"					I[::. :::;!	 -::::			.*!*.	[-
LHHL	CG RAM (7)	* * * * * * * * * * * * * * * * * * *				I.,!	***	11	-:::	." <i>,</i> !!			[!!!
LННН	CG RAM (8)		==	*****			****	1,.,1	====	 !!]:-: <u>[</u>	:	! [*] !	1,,,	!!
HLLL	CG RAM (1)		!	}		: · · · · ·	***	[:-:]			.;;		-1,	11	ļ-;".	
HLLH	CG RAM (2)		". !	}		1,,1					i	***				-:-!
HLHL	CG RAM (3)	."."	[[==	*,	****	· ;;			[,I		::- ::-	****		ļ	
нгнн	CG RAM (4)	**;	}	11			***	-=	**	·**.*	*****	-::::	! ! !	1"1"1	1,.:*	* #
HHLL	CG RAM (5)	*****	: =	•===		****	*****		,". "] .!.]:::-				
HHLH	CG RAM (6)	:":,:	****	*****		***		***	*.		::		***			
HHHL	CG RAM (7)		11			*** <i>,</i>		***,*	.". !***!	II					!""! !	
нннн	CG RAM (8)			-"":		****	!)		I	:: ::						



11.Instruction Table

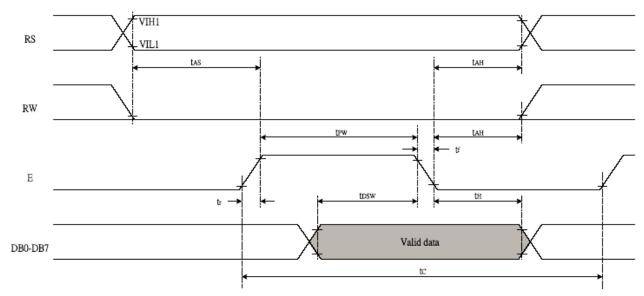
Instruction	Instruction Code								Description	Execution time		
instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	(fosc=270Khz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC	1.52ms
Return Home	0	0	0	0	0	0	0	0	1	_	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.52ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	SH	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	37µs
Display ON/OFF Control	0	0	0	0	0	0	1	D	С	В	D=1:entire display on C=1:cursor on B=1:cursor position on	37μs
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	-	_	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	37µs
Function Set	0	0	0	0	1	DL	N	F	_	_	DL:interface data is 8/4 bits N:number of line is 2/1 F:font size is 5x11/5x8	37μs
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter	37μs
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter	37μs
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0µs
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM)	37μs
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM)	37μs

* "-": don't care



12. Timing Characteristics

12.1 Writing data from MPU to ST7066U

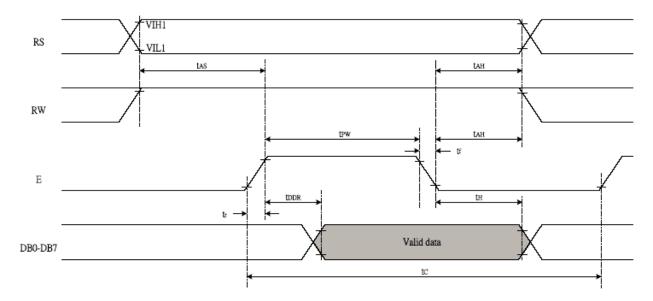


 $Ta=-30\sim+85^{\circ}C$, $VDD=5.0\pm0.5V$

TC	Enable Cycle Time	Pin E	1200	1	1	ns
TPW	Enable Pulse Width	Pin E	140	1	1	ns
TR,TF	Enable Rise/Fall Time	Pin E	-	-	25	ns
TAS	Address Setup Time	Pins: RS,RW,E	0	-	-	ns
TAH	Address Hold Time	Pins: RS,RW,E	10	-	-	ns
TDSW	Data Setup Time	Pins: DB0 - DB7	40	1	1	ns
TH	Data Hold Time	Pins: DB0 - DB7	10	1	1	ns

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12.2Reading data from ST7066U to MPU



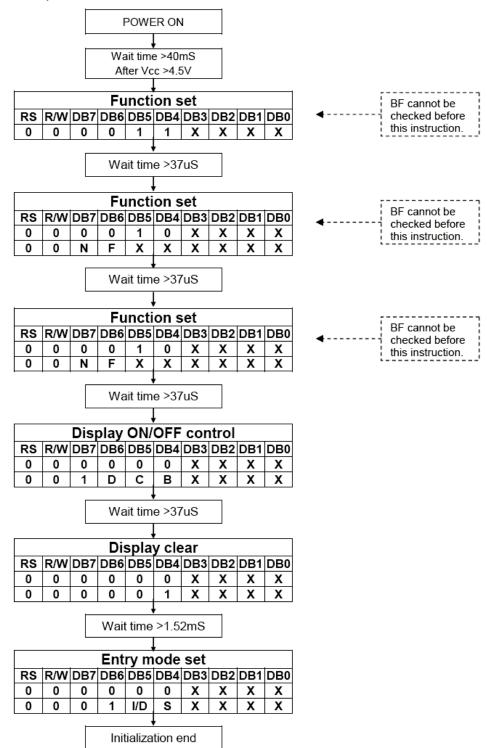
Ta=-30 \sim +85 $^{\circ}$ C, VDD=5.0 \pm 0.5V

Read Mode	;	(Reading Data from ST7066U to MPU)						
TC	Enable Cycle Time	Pin E	1200	-	-	ns		
TPW	Enable Pulse Width	Pin E	140	-	-	ns		
TR,TF	Enable Rise/Fall Time	Pin E	-	-	25	ns		
TAS	Address Setup Time	Pins: RS,RW,E	0	-	-	ns		
ТАН	Address Hold Time	Pins: RS,RW,E	10	-	-	ns		
TDDR	Data Setup Time	Pins: DB0 - DB7	-	-	100	ns		
TH	Data Hold Time	Pins: DB0 - DB7	10	-	-	ns		



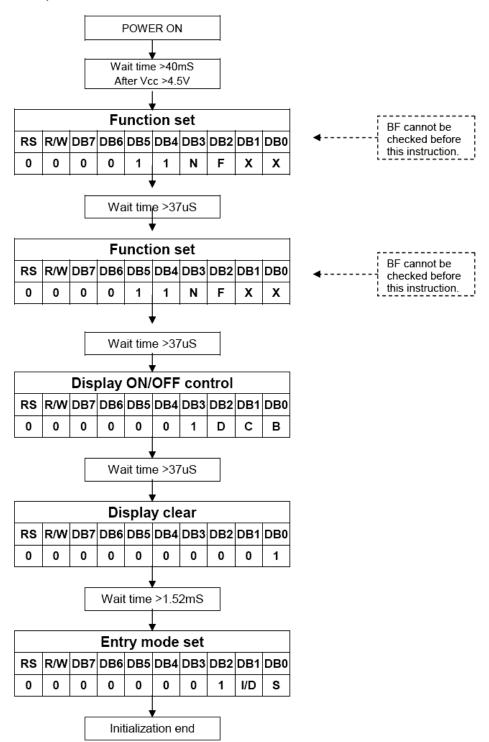
13. Initializing of LCM

4-bit Interface (fosc=270KHz)



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8-bit Interface (fosc=270KHz)





14. Reliability

Content of Reliability Test (wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C ,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5k Ω CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.



15. Inspection specification

NO	Item	Criterion							
01	Electrical Testing	1.2 Missing char 1.3 Display malf 1.4 No function of 1.5 Current cons 1.6 LCD viewing 1.7 Mixed produ	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 						
02	Black or white spots on LCD (display only)	three white o	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3m 						
03	LCD black spots, white spots,	3.1 Round type: $\Phi = (x + y) / X$		ring drawing $SIZE$ $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$) 2	2.5			
	contamination (non-display)	3.2 Line type : (A	As following Length L≤3.0 L≤2.5	Width $W \le 0.02$ $0.02 < W \le 0.03$	Acceptable Q TY Accept no dense 2 As round type	2.5			
04	Polarizer bubbles	If bubbles are vis judge using black specifications, no to find, must che specify direction	k spot ot easy eck in	Size Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5			

NO	Item		Criterion		AQL				
05	Scratches	Follow NO.3 LCD blace	ek spots, white spots, con	ntamination					
	Scratches	k: Seal width t: L: Electrode pad length 6.1 General glass chip:	efine: gth y: Chip width z: Chip thickness th t: Glass thickness a: LCD side length e pad length:						
		z: Chip thickness	y: Chip width	x: Chip length					
	Chinad	Z≦1/2t	Not over viewing area	x ≤ 1/8a					
06	Chipped glass	$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	2.5				
		6.1.2 Corner crack:	chips, x is total length of	y					
		z: Chip thickness	y: Chip width	x: Chip length					
		Z≦1/2t	Not over viewing area	x ≤ 1/8a					
		$1/2t < z \le 2t$	Not exceed 1/3k	x≤1/8a					
		⊙ If there are 2 or more	chips, x is the total lengtl	h of each chip.					



NO	Item	Criterion	AQL
			AQL
		Symbols: x: Chip ength y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:	
		y: Chip width x: Chip length z: Chip thickness	
		$y \le 0.5 \text{mm} \qquad \qquad x \le 1/8 \text{a} \qquad \qquad 0 < z \le t$	
06	Glass crack	6.2.2 Non-conductive portion:	2.5
		y: Chip width x: Chip length z: Chip thickness	
		$y \le L \qquad \qquad x \le 1/8a \qquad \qquad 0 < z \le t$	
		 ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. ⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged. 6.2.3 Substrate protuberance and internal crack. y: width x: length y ≤ 1/3L x ≤ a 	





NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't' t light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB 	2.5 2.5 0.65 2.5 2.5 0.65 2.5 2.5 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65





NO	Item	Criterion		
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it causes the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65	



16. Material List of Components for RoHS

1. Declaration that all of or part of products (with the mark "N" in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

•

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs		
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm		
Above limited value is set up according to RoHS.								

2. Process for RoHS requirement:

(1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.

(2) Heat-resistance temp. :

Reflow: 250°C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235°C ±5degrees;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

17. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.



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